

IMDT V2H DEEPX SBC

The IMDT V2H DEEPX SBC is a powerful, compact mini-computer engineered for AI-driven vision applications. Fully compatible with the DEEPX M1 module, it harnesses the M1's industry-leading energy efficiency—delivering up to 25 TOPs (200 eTOPs) at under 5W—alongside an additional 15 TOPs (dense) and 80 TOPs (sparse) from the integrated V2H processor. This enables real-time, high-performance AI processing in a small footprint.

Ideal for robotics, drones, and smart city deployments, the V2H SBC offers a balanced mix of performance, efficiency, and cost-effectiveness. Its extensive I/O options, modular assembly support, and comprehensive on-board connectivity make it an excellent choice for developers creating intelligent, compact system designs.







- Based on IMDT RZ/V2H SOM
- Supports 4-lane PCIe Gen3
- Multi camera connectivity, up to 4 x 4-lane MIPI CSI
- 6-DOF IMU,3-Axis magnetometer for motion sensing
- Full Connectivity
 - M.2 NGFF Key-E for Wi-Fi module or Al accelerator
 - M.2 NGFF Key-B for cellular module
 - Wi-Fi 4 , Dual-band
 - 2 x RJ-45 , 1000Base-T, optional PoE
- Dimensions (WxLxH): 125 x 110 x 15mm
- Quick prototyping with IMDT's V2H DEEPX Evaluation Kit



DX-M1 M.2 LPDDR5×2

Type: Al Accelerator Al Perf: 25 TOPs / 3~5W Form Factor: M.2 M Key (22 × 80 mm) Interface: PCle Gen.3 x4 Memory: 4GB LPDDR5, QSPI 1Gbit NAND



Delivering 15+25 TOPs of combined AI performance









Multi-camera solution



Full connectivity

Key Features



Product Specification

Specification	Description	Specification	Description
CPU:	RZ/V2H, 4xA55+M33+2xR8,	Audio:	3.5mm Audio jack for stereo
	VPU, NPU, GPU, ISP		headset with mic
			Onboard PDM digital microphone
Memories:	QSPI NOR flash, 64MBytes		
	Secure EEPROM	Sensors:	Temperature & Humidity
	Micro SD card slot		6-DOF IMU
			3-Axis magnetometer
Connectivity:	Supports 4-lane PCIe Gen3		
	2.4/5GHz Wi-Fi 4, Dual-band +	Power:	USB-C PD power
	Bluetooth 5.2 BR/EDR/LE		POE+GTP (with addition of power supply module)
	2 x RJ-45 , 1000Base-T, Optional PoE		Optional external power supply
	1 x USB 3.2 type-A connector		
	2 x USB 2.0 connectors	Misc	RTC
	M.2 NGFF Key-E can be used for Wi-Fi module or Al accelerator		Fan control
	M.2 NGFF Key-B can be used for cellular Module		Boot DIP-Switch
	RS-232 transceiver on board		LEDs
	CAN-FD transceiver on board		Debug - On board UART to USB bridge with
			USB-C connector
Camera:	4 x 4-lane MIPI CSI interface for cameras via IAS connectors	Extensions:	SPI, I2C, I2S, PDM, GPIOs, Analog headers
	ISP		Extension connectors with power and I2C
		Dimensions:	125 x 110 x 15mm

The IMDT V2H DEEPX Evaluation Kit

Provides a ready-to-use development environment for streamlined prototyping and system integration. Built around the V2H DEEPX SBC and fully integrated with the DEEPX M1 module, the kit exposes all key interfaces and connectivity features, making it easy to evaluate performance and explore real-world AI use cases. It enables developers to accelerate testing, fine-tune applications, and validate designs with minimal setup effort. It is an ideal platform for transitioning quickly from concept to deployment.



What's in the box



Block diagram



About IMDT

IMDT Technologies, with headquarters in the UK and Israel, specializes in creating advanced vision and AI-powered products and systems. Leveraging extensive engineering experience in real-time applications, including vision and AI on edge hardware and software, IMDT has excelled in design, development, and manufacturing since its inception in 2017. The company globally addresses complex vision and AI challenges, focusing on partnerships with leading chip manufacturers and delivering turnkey projects in medical, robotics, smart cities, smart homes, and industrial IoT.

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